

Final Design and Safety Review of the INTT Ladder and Barrels

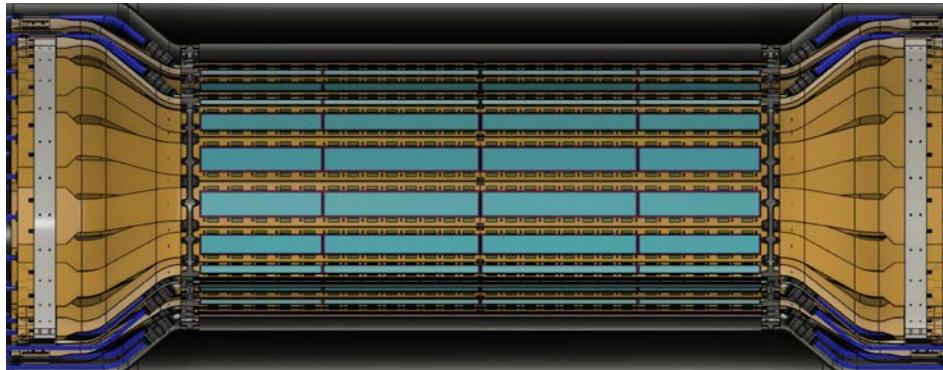
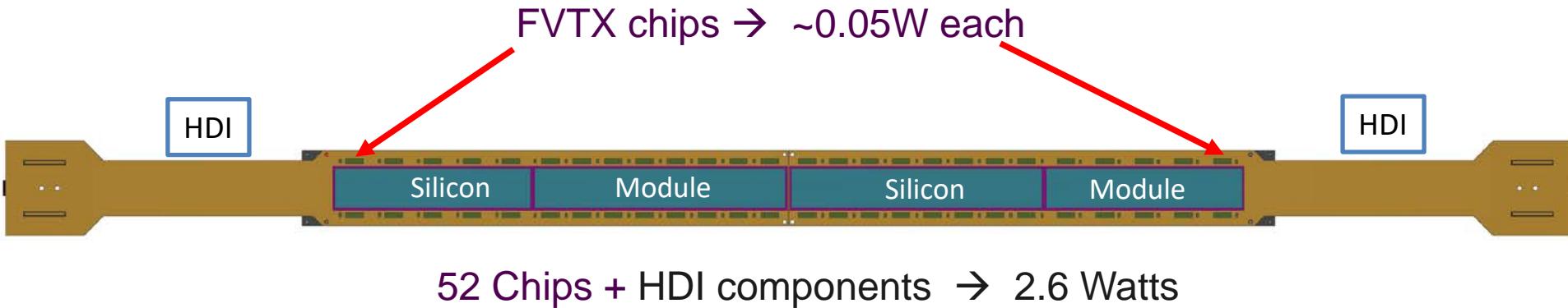
INTT Cooling System

WBS: 3.0X

Rob Pisani, BNL

June 1th, 2020

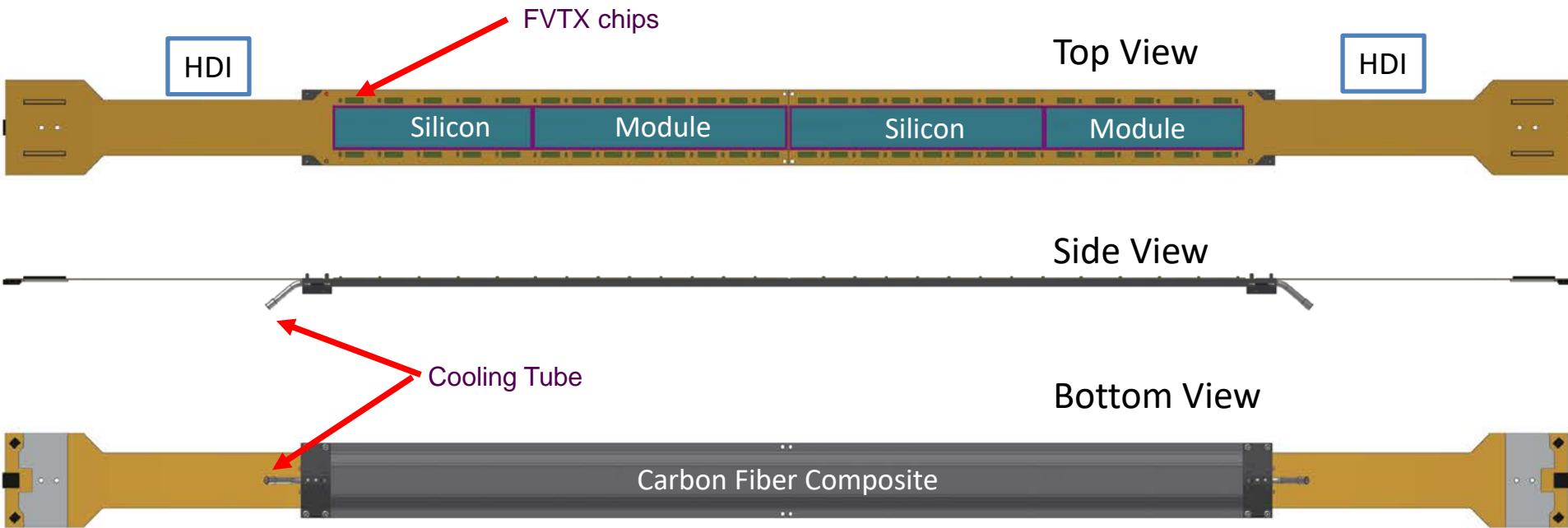
Ladder – Stave with Two HDIs



Rounding up to 3Watts per ladder

$$\underline{3 \text{ W} \times 56 \text{ ladders} = 168 \text{ W}}$$

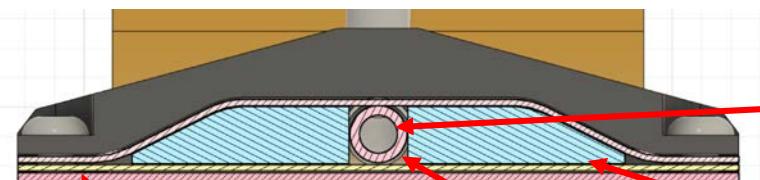
Ladder – Stave with Two HDIs



Stave Design and Thermal Load



What we care about for Cooling



3M Thermal Epoxy
TC2810

Loctite 2902
(Silver Epoxy)

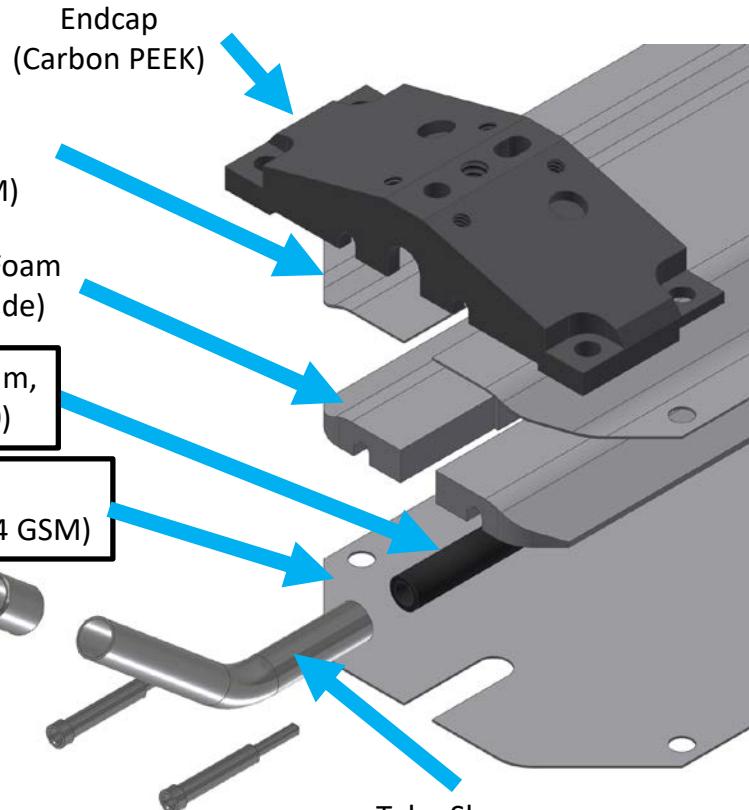
CFC Formed
(K13C2U +
20301A 34 GSM)

Rohacell 110 RIST Foam
(polymethacrylimide)

CFC Tube (OD: 3mm,
ID: 2mm) (T700)

CFC Flat
(K13C2U + 20301A 34 GSM)

Graphite Epoxy
(EP75-1)

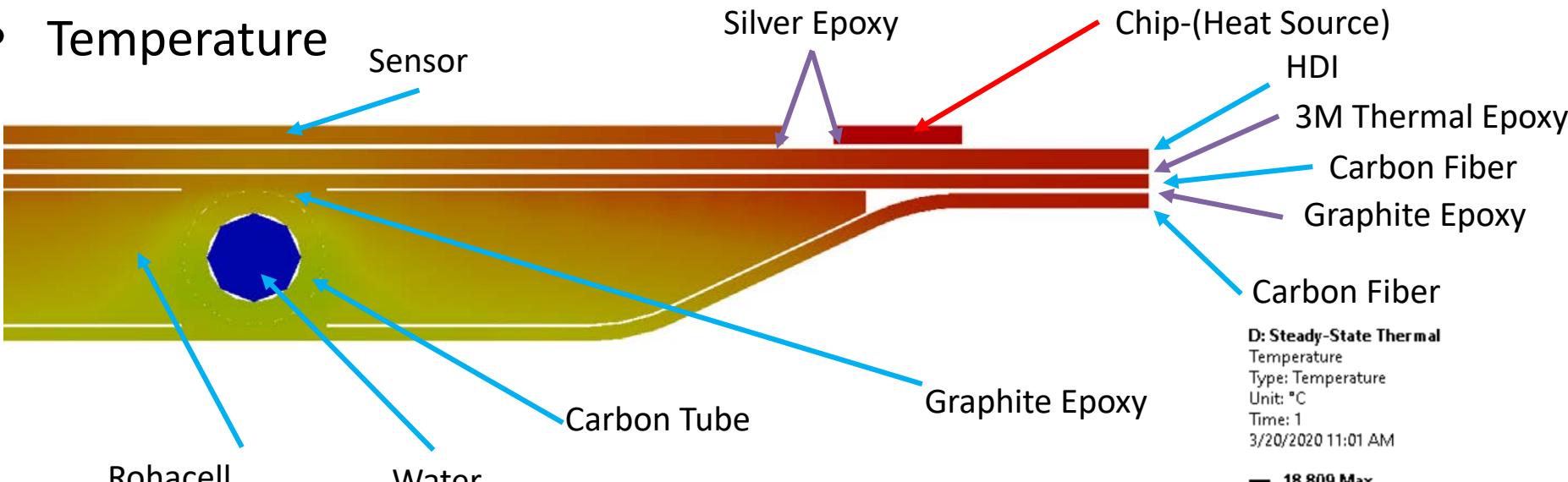


Tube Sleeve
(316 Stainless)

Thermal – Midplane Cross Section

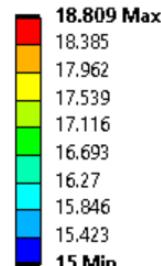


- Temperature



The heat is applied as a 0.0055 W/mm^3 , which is about 0.05W per chip, or 2.6W total. There is also convection in the model, which adds about a 0.4W load. Flow Rate is 120ccm of water.

D: Steady-State Thermal
Temperature
Type: Temperature
Unit: °C
Time: 1
3/20/2020 11:01 AM

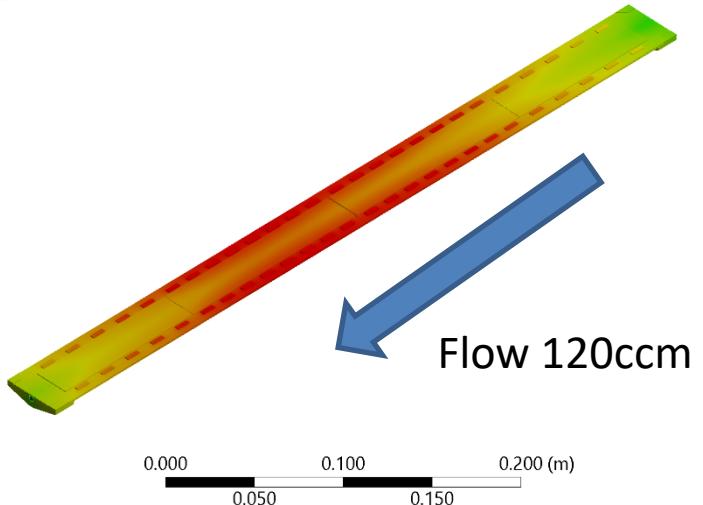
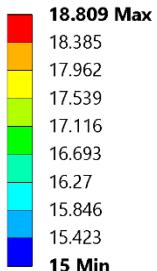


Thermal – Temperatures

Stave ΔT – $3.8^\circ C$ ($6.8^\circ F$)

D: Steady-State Thermal

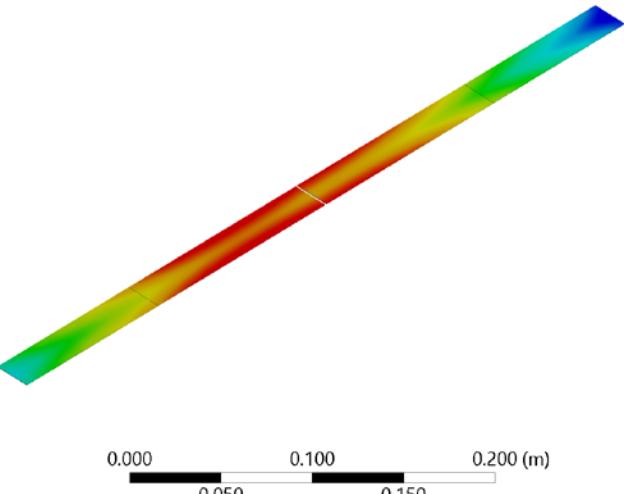
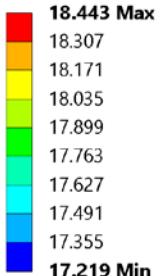
Temperature
Type: Temperature
Unit: $^\circ C$
Time: 1
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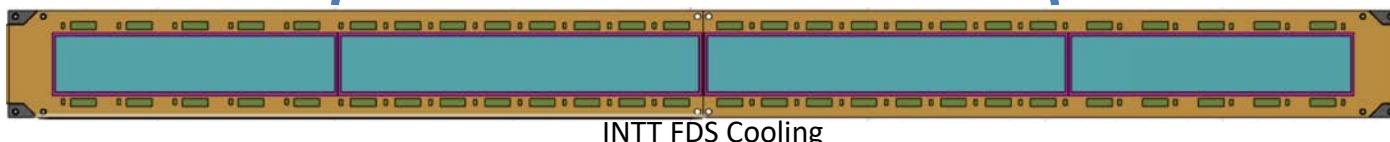
Sensors ΔT – $1.2^\circ C$ ($2.2^\circ F$)

D: Steady-State Thermal

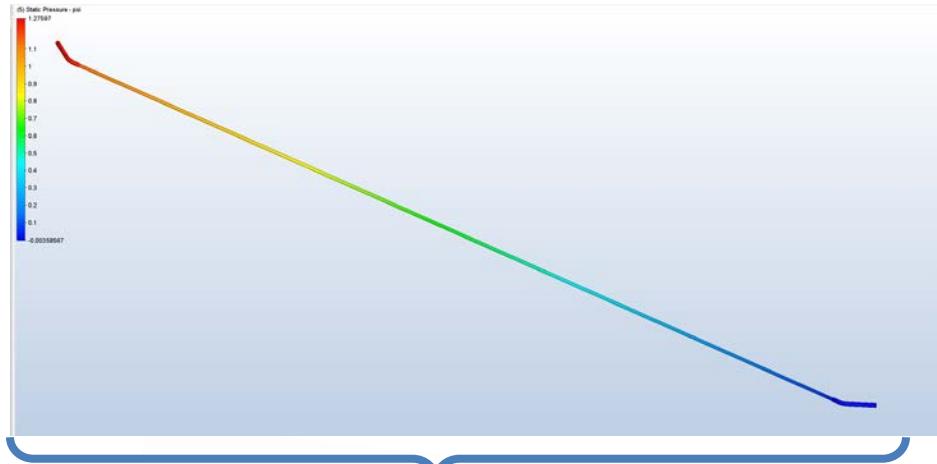
Temperature 2
Type: Temperature
Unit: $^\circ C$
Time: 1
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Higher Chip Density



Pressures and flow analysis



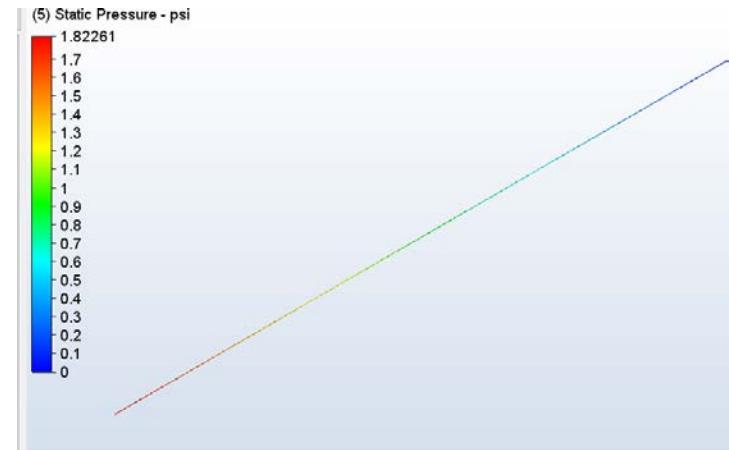
Coupling with 3mm bore

3mm ID 4mm OD
2.8m Polyethylene
Tubing

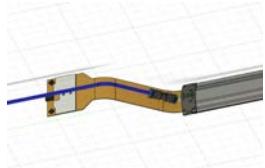
INTT FDS Cooling

1.3psi to obtain a flow of 120ccm through the ladder.

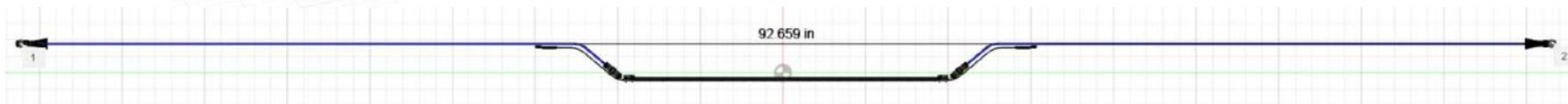
Additional 1.8psi for the 2.8m I.D. 3mmID Poly Tubing



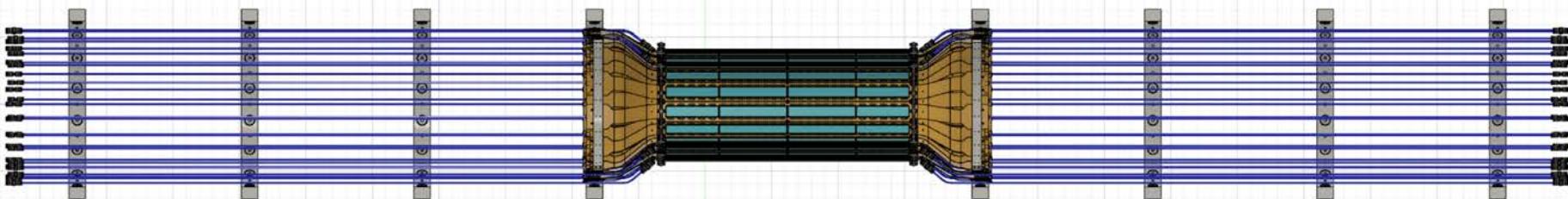
Pressures and flows



We will need 3.4 psi to obtain a flow of 120ccm per ladder through the barrel.

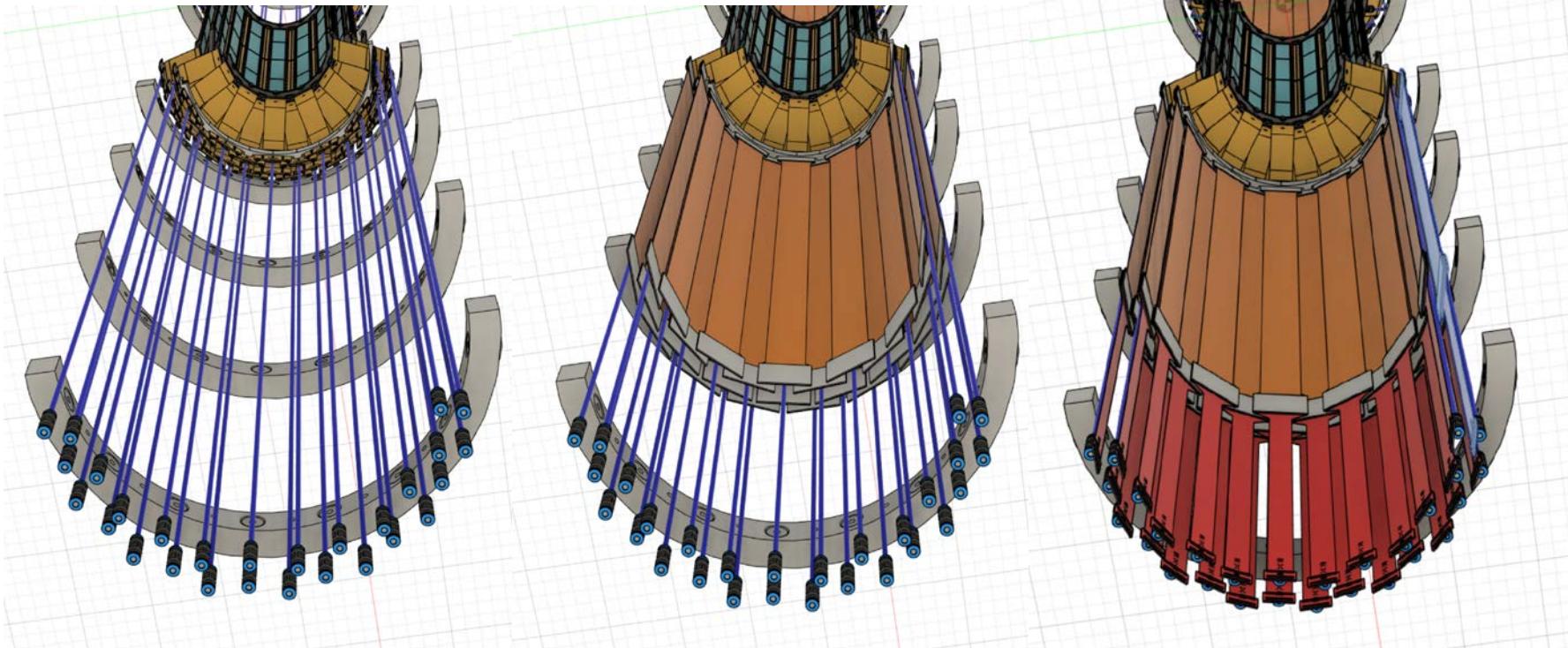


Half barrel with 28 ladders



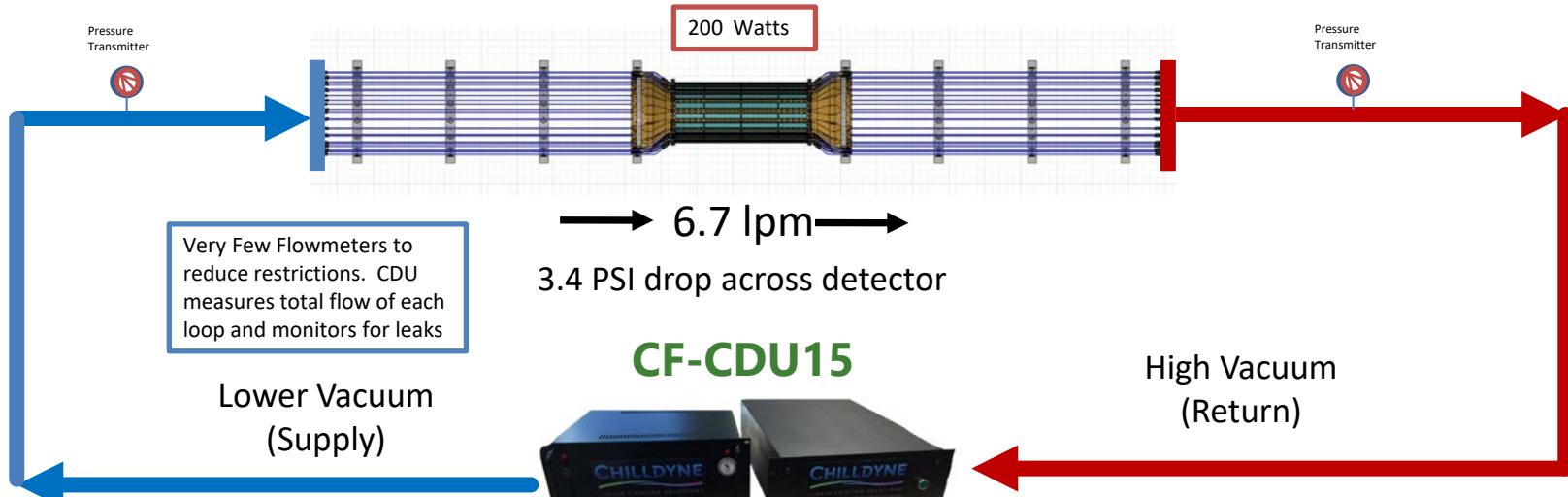
All Ladders will be plumbed in parallel. Manifold will be external to detector to allow for modifications post installation.

The INTT

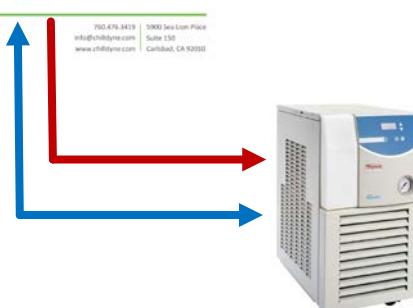


INTT FDS Cooling

Sub-Atmospheric Cooling System



- Monitors water temperature flow rate and heat transfer, fills, drains and test for leaks
- 9 lpm at $\frac{1}{2}$ atmosphere
- Failure tolerant, negative pressure system
- Data logging of key performance parameters
- Web based software: control and monitor from anywhere.
- Automatic drain and fill under remote control.
- Leak-Proof-uses negative pressure on both supply and return so if a leak occurs anywhere air will flow into the system instead of coolant leaking out.

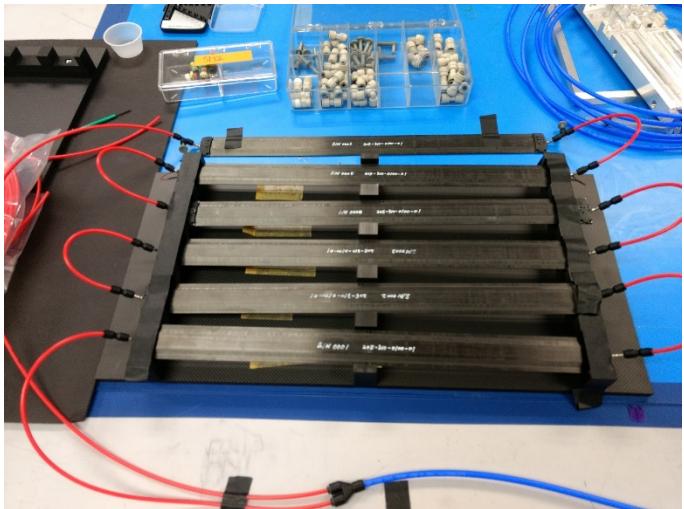


Status

- CF-CDU15 Purchased and received March 2019
- Testing Flows and load capacities
- Have not finished testing because of lab closure

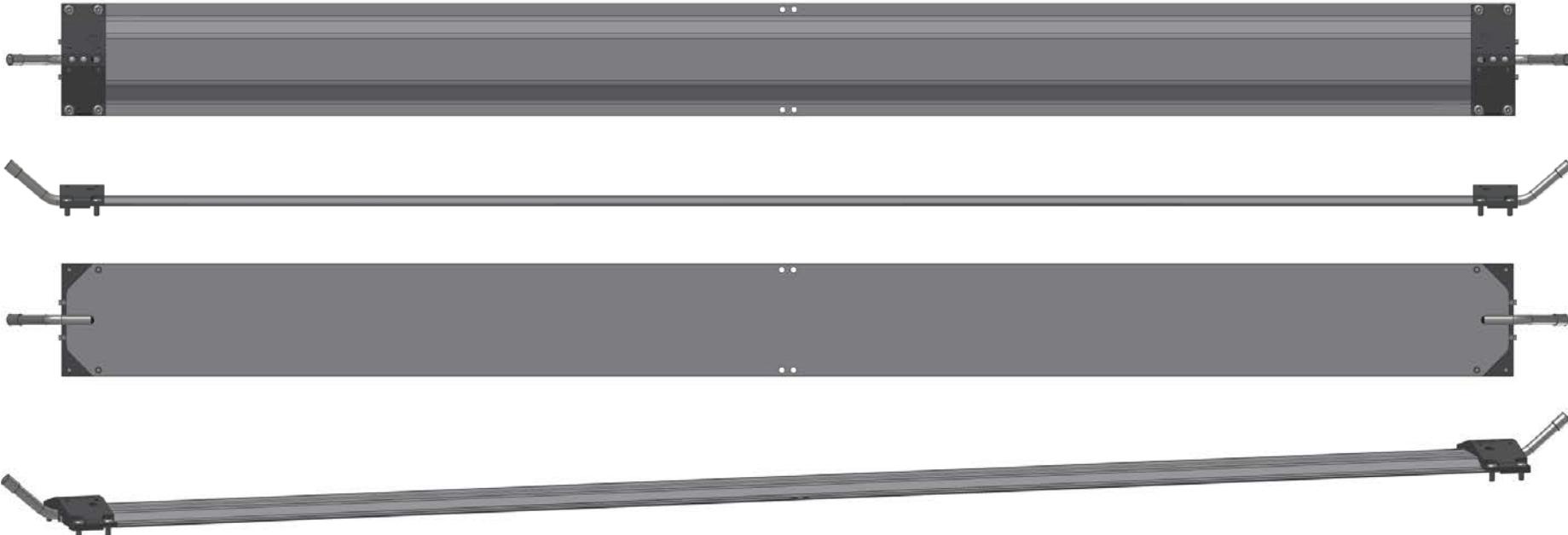


- First Articles received March 2019
- Pressure drop and Flow testing was in progress
- Stopped because of Lab Closure



Back Up notes
Will not post at review

Stave Design



Thickness: 0.76 mm
Height: 3.76 mm
Width: 38.00 mm
Length: 497 mm

Material: Carbon Fiber,
Polymethacrylimide (PMI),
Stainless Steel and Epoxy
(radiation length = 0.40%)

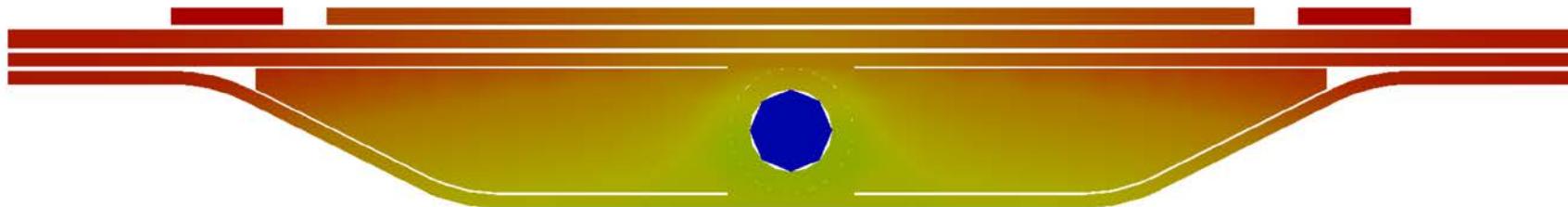
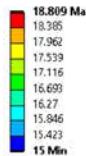
Thermal – Midplane Cross Section



Temperature

The heat is applied as a 0.0055 W/mm^3 , which is about 0.06W per chip, or 3W total. There is also convection in the model, which adds about a 0.4W load. The flow rate is 0.002kg/s or 120ccm .

D: Steady-State Thermal
Temperature
Type: Temperature
Unit: °C
Time: 1
3/20/2020 11:01 AM



Heat Flux

D: Steady-State Thermal
Total Heat Flux
Type: Total Heat Flux
Unit: W/m²
Time: 1
3/20/2020 10:59 AM

